

# Linear IC Converter

CMOS

## D/A Converter for Digital Tuning (12-channel, 8-bit, on-chip OP amp, low-voltage)

# MB88346L

### ■ DESCRIPTION

The Fujitsu MB88346L is an 8-bit D/A converter capable of low-voltage operation, and designed with a built-in amp on each of its 12 analog output lines for large-current drive capability.

The use of serial data input means that only three control lines are required, and enables cascade connection of multiple MB88346L chips.

The MB88346L is suitable for applications such as electronic volume controls and replacement of semi-fixed resistors in tuning systems.

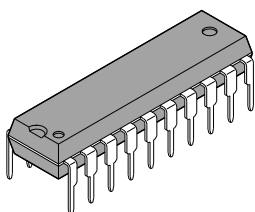
In addition, the MB88346L is both function-compatible and pin-compatible with the MB88346B now in use, allowing easy substitution of the MB88346L for reduced supply voltage.

### ■ FEATURES

- Low voltage operation ( $V_{CC}/V_{DD}$ : 2.7 to 3.6 V)
- Ultra-low power consumption (0.5 mW/ch at  $V_{CC} = 3$  V)
- Ultra-compact space-saving package lineup (SSOP-20)
- Contains 12-channel R-2R type 8-bit D/A converter
- On-chip analog output amps (sink current max. 1.0 mA, source current max. 1.0 mA)
- Analog output range from 0 to  $V_{CC}$
- Two separate power supply/ground lines for MCU interface block/operational amplifier output buffer block and D/A converter block
- Serial data input, maximum operating speed 2.5 MHz  
(maximum operating speed in cascade connection is 1.5 MHz)
- CMOS process
- Package lineup includes DIP 20-pin, SOP 20-pin, SSOP 20-pin.

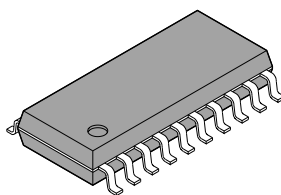
### ■ PACKAGE

20-pin Plastic DIP



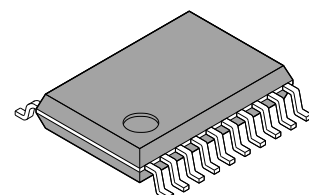
(DIP-20P-M02)

20-pin Plastic SOP



(FPT-20P-M01)

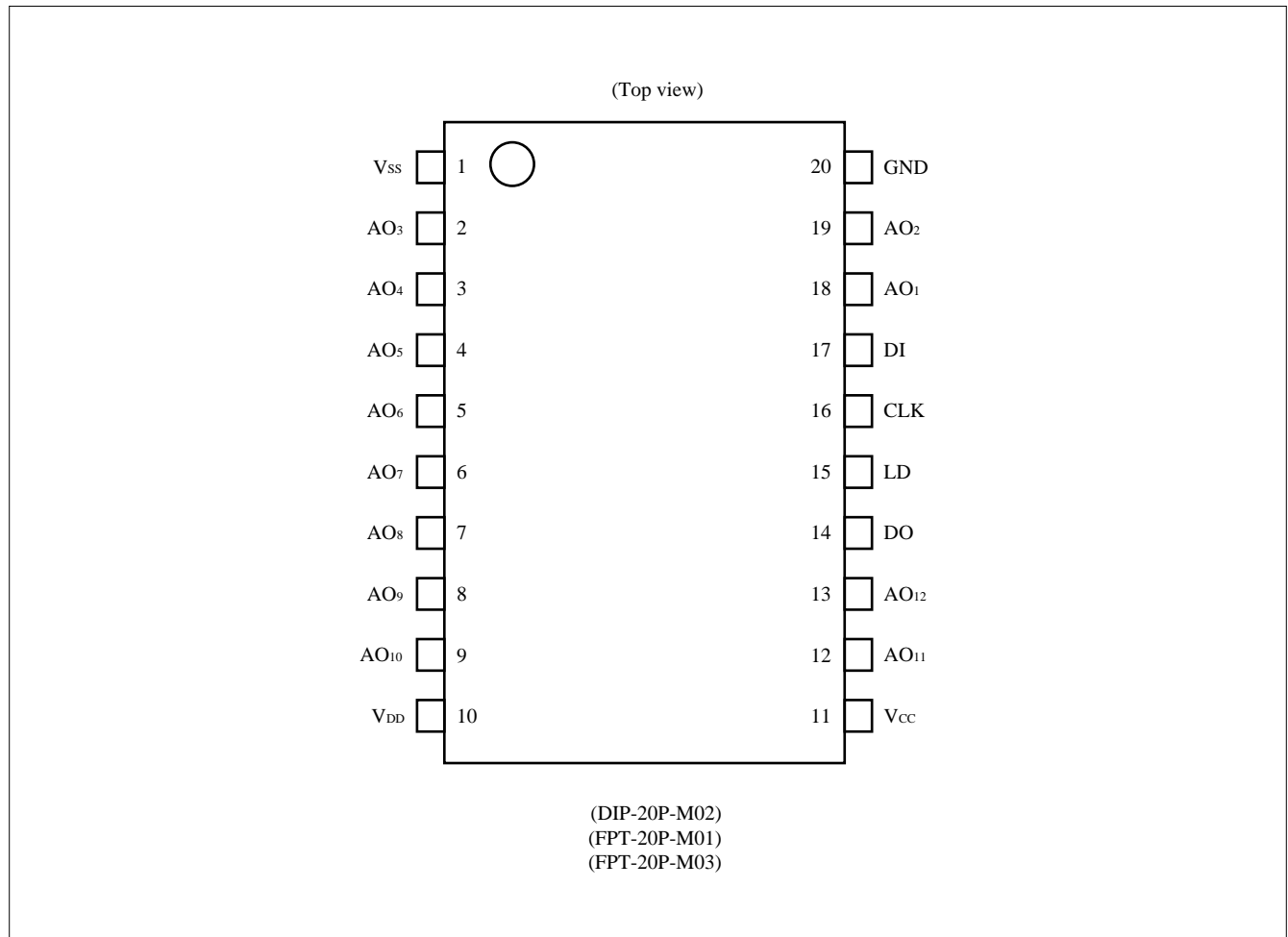
20-pin Plastic SSOP



(FPT-20P-M03)

# MB88346L

## ■ PIN ASSIGNMENT

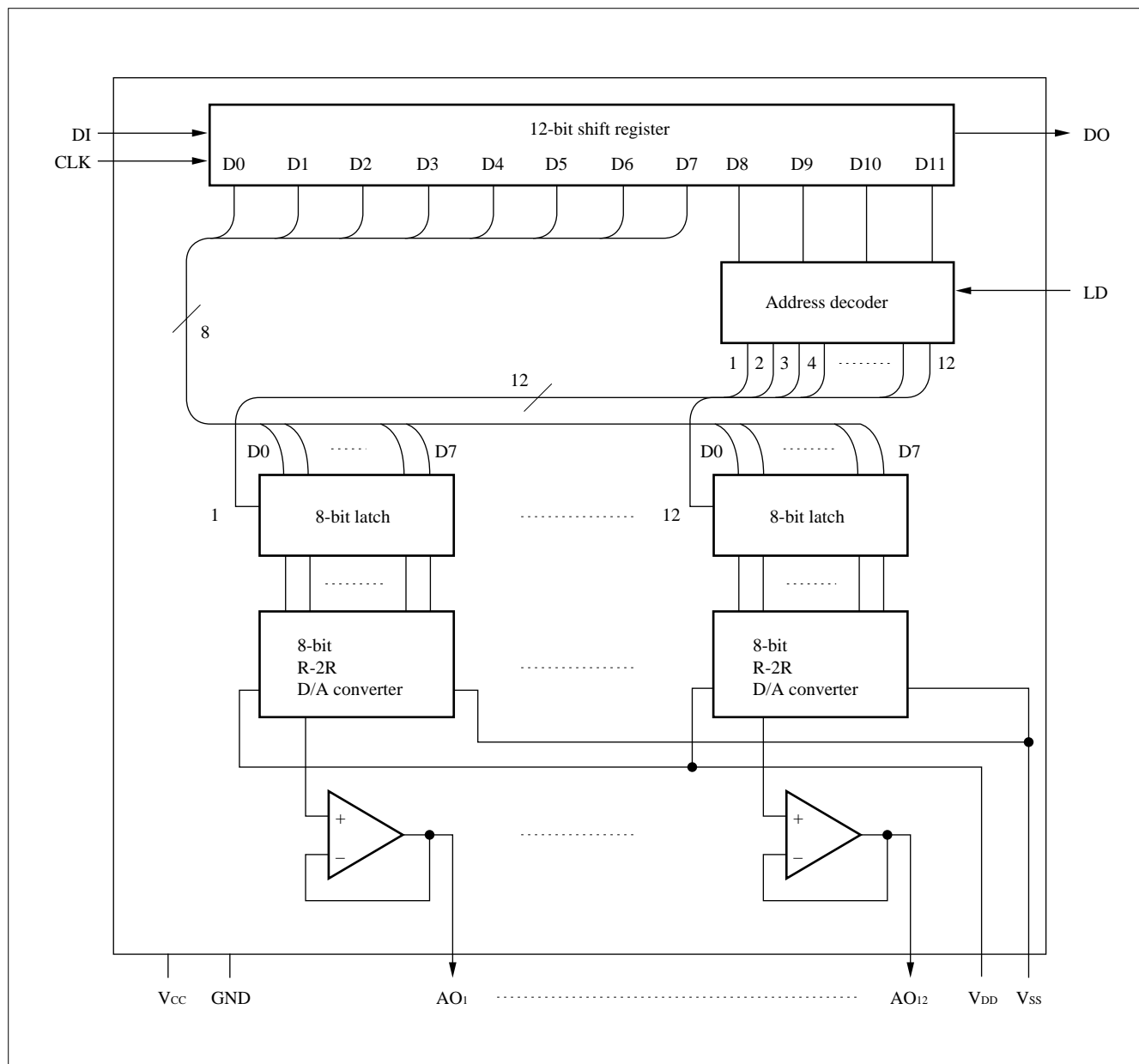


## ■ PIN DESCRIPTION

Pin No.	Symbol	I/O	Function
17	DI	I	Serial address/data input to the internal 12-bit shift register: The address/data format is that upper 4 bits (D11 to D8) indicate an address and lower 8 bits (D7 to D0) indicate data. The D11 (MSB) is the first-in bit and D0 (LSB) is the last-in bit.
14	DO	O	Outputs MSB bit data from 12-bit shift register.
16	CLK	I	Shift clock input to the internal 12-bit shift register: At the rising edge of CLK data on the DI pin is shifted into the LSB of the shift register and contents of the shift register are shifted right (to the MSB).
15	LD	I	Load strobe input for a 12-bit address/data: A high level on the LD pin latches a 4-bit address (upper 4 bits: D11 to D8) of the internal 12-bit shift register into the internal address decoder, and writes 8-bit data (lower 8 bits: D7 to D0) of the shift register into an internal data latch selected by the latched address.
18 19 2 3 4 5 6 7 8 9 12 13	AO <sub>1</sub> AO <sub>2</sub> AO <sub>3</sub> AO <sub>4</sub> AO <sub>5</sub> AO <sub>6</sub> AO <sub>7</sub> AO <sub>8</sub> AO <sub>9</sub> AO <sub>10</sub> AO <sub>11</sub> AO <sub>12</sub>	O	8-bit D/A output pins with OP amps.
11	V <sub>CC</sub>	—	MCU interface and OP amp power supply pin.
20	GND	—	MCU interface and OP amp ground pin.
10	V <sub>DD</sub>	—	D/A converter power supply pin.
1	V <sub>SS</sub>	—	D/A converter ground pin.

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## ■ BLOCK DIAGRAM

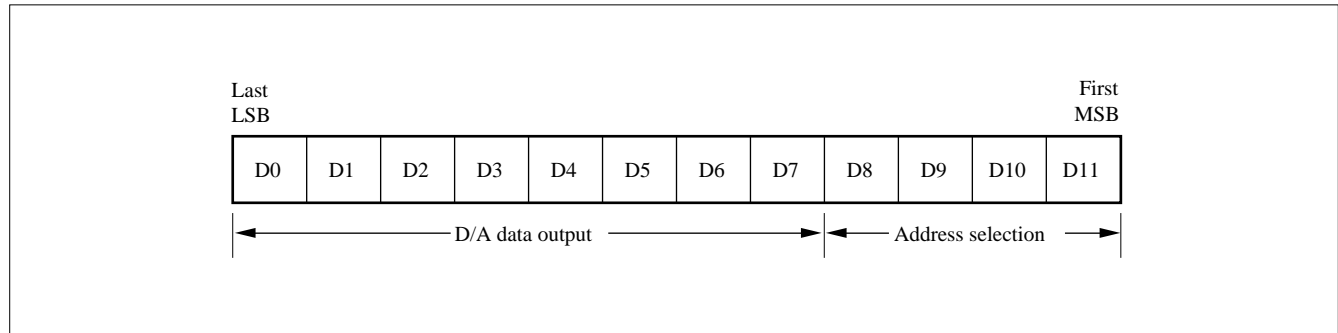


## ■ DATA CONFIGURATION

The MB88346L has a 12-bit shift register for chip control functions. The 12-bit shift register must be used to set up data in the configuration shown below.

The data configuration has a total of 12 bits, four for address selection and eight for D/A data output.

### 1. Shift Register Control Data Configuration



### 2. D/A Converter Control Signals

D0	D1	D2	D3	D4	D5	D6	D7	D/A data output
0	0	0	0	0	0	0	0	$\frac{2}{255} V_{SS}$
1	0	0	0	0	0	0	0	$\frac{1}{255} V_{LB}$
0	1	0	0	0	0	0	0	$\frac{2}{255} V_{LB} \times 2 + V_{SS}$
⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮
0	1	1	1	1	1	1	1	$\frac{2}{255} V_{LB} \times 254 + V_{SS}$
1	1	1	1	1	1	1	1	$\frac{2}{255} V_{DD}$

$$V_{LB} = (V_{DD} - V_{SS})/255$$

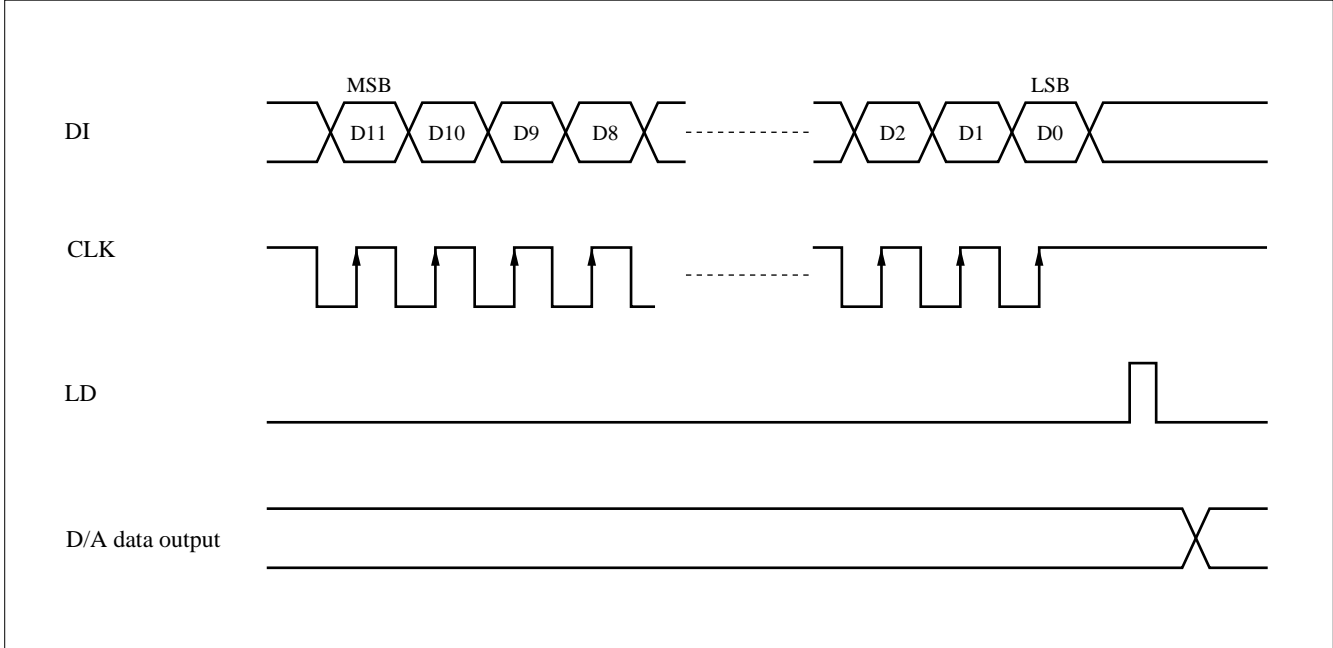
# MB88346L

## 3. Address Selection Signals

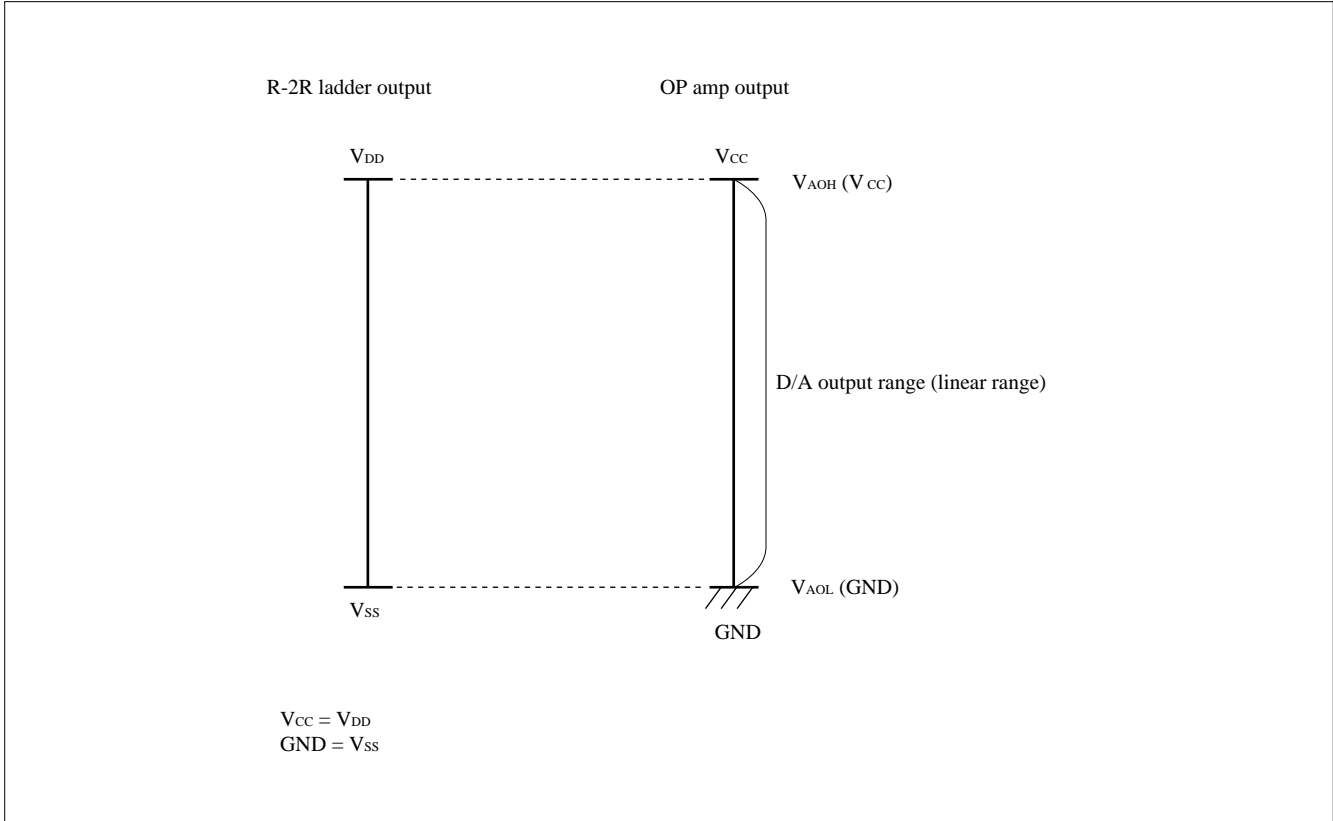
D8	D9	D10	D11	Address selection
0	0	0	0	Don't Care
0	0	0	1	AO <sub>1</sub> selection
0	0	1	0	AO <sub>2</sub> selection
0	0	1	1	AO <sub>3</sub> selection
0	1	0	0	AO <sub>4</sub> selection
0	1	0	1	AO <sub>5</sub> selection
0	1	1	0	AO <sub>6</sub> selection
0	1	1	1	AO <sub>7</sub> selection
1	0	0	0	AO <sub>8</sub> selection
1	0	0	1	AO <sub>9</sub> selection
1	0	1	0	AO <sub>10</sub> selection
1	0	1	1	AO <sub>11</sub> selection
1	1	0	0	AO <sub>12</sub> selection
1	1	0	1	Don't Care
1	1	1	0	Don't Care
1	1	1	1	Don't Care

■ OPERATING DESCRIPTION

1. Timing Chart for Data Condition Setup



2. Analog Output Voltage Range



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## ■ ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Condition	Value		Unit
			Min.	Max.	
Power supply voltage	V <sub>CC</sub>	GND used as reference, Ta = 25°C	-0.3	+7.0	V
	V <sub>DD</sub> *		-0.3	+7.0	V
Input voltage	V <sub>IN</sub>		-0.3	V <sub>CC</sub> + 0.3	V
Output voltage	V <sub>OUT</sub>		-0.3	V <sub>CC</sub> + 0.3	V
Power consumption	P <sub>D</sub>	—	—	250	mW
Operating temperature	Ta	—	-20	+85	°C
Storage temperature	T <sub>stg</sub>	—	-55	+150	°C

\*: V<sub>CC</sub> ≥ V<sub>DD</sub>

## ■ RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Condition	Value			Unit
			Min.	Typ.	Max.	
Power supply voltage 1	V <sub>CC</sub>	—	2.7	—	3.6	V
	GND	—	—	0	—	V
Power supply voltage 2	V <sub>DD</sub>	V <sub>DD</sub> - V <sub>SS</sub> ≥ 2.0 V	2.0	—	V <sub>CC</sub>	V
	V <sub>SS</sub>		GND	—	V <sub>CC</sub> - 2.0	V
Analog output source current	I <sub>AL</sub>	V <sub>CC</sub> = 3.0 V	—	—	1.0	mA
Analog output sink current	I <sub>AH</sub>	V <sub>CC</sub> = 3.0 V	—	—	1.0	mA
Oscillator limiting output capacity	C <sub>AL</sub>	—	—	—	0.1	μF
Digital data value range	—	—	#00	—	#FF	—
Operating temperature	Ta	—	-20	—	+85	°C



## ■ ELECTRICAL CHARACTERISTICS

### 1. DC Characteristics

#### (1) Digital Block

( $V_{DD}$ ,  $V_{CC} = +2.7\text{ V to }3.6\text{ V}$  ( $V_{CC} \geq V_{DD}$ ),  $GND$ ,  $V_{SS} = 0\text{ V}$ ,  $T_a = -20^\circ\text{C to }+85^\circ\text{C}$ )

Parameter	Symbol	Pin	Condition	Value			Unit
				Min.	Typ.	Max.	
Power supply voltage	$V_{CC}$	$V_{CC}$	—	2.7	3.0	3.6	V
Power supply current 1	$I_{CC}$		Stationary (CLK signal stopped), no load	—	1.2	3.0	mA
Input leak current	$I_{ILK}$	CLK DI LD	$V_{IN} = 0\text{ to }V_{CC}$	-10	—	10	$\mu\text{A}$
L level input voltage	$V_{IL}$		—	—	—	$0.2 V_{CC}$	V
H level input voltage	$V_{IH}$		—	$0.8 V_{CC}$	—	—	V
L level output voltage	$V_{OL}$	DO	$I_{OL} = 2.5\text{ mA}$	—	—	0.4	V
H level output voltage	$V_{OH}$		$I_{OH} = -400\ \mu\text{A}$	$V_{CC} - 0.4$	—	—	V

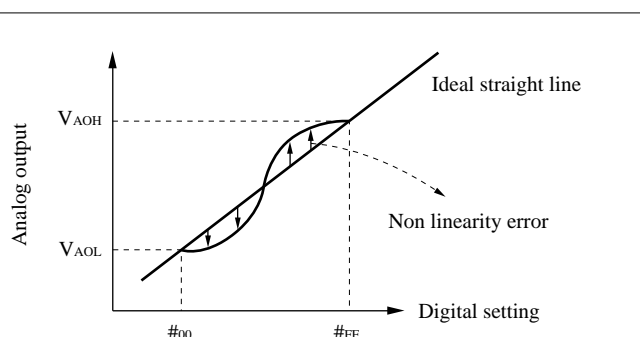
#### (2) Analog Block 1

( $V_{DD}$ ,  $V_{CC} = +2.7\text{ V to }3.6\text{ V}$  ( $V_{CC} \geq V_{DD}$ ),  $GND$ ,  $V_{SS} = 0\text{ V}$ ,  $T_a = -20^\circ\text{C to }+85^\circ\text{C}$ )

Parameter	Symbol	Pin	Condition	Value			Unit
				Min.	Typ.	Max.	
Power consumption	$I_{DD}$	$V_{DD}$	Maximum setting value from #00 to #FF	—	0.6	1.5	mA
Analog voltage	$V_{DD}$	$V_{DD}$	$V_{DD} - V_{SS} \geq 2.0$	2.0	—	$V_{CC}$	V
	$V_{SS}$	$V_{SS}$		GND	—	$V_{CC} - 2.0$	V
Resolution	Res	AO <sub>1</sub> to AO <sub>12</sub>	—	—	8	—	bits
Monotonic increase	Rem		$V_{DD} \leq V_{CC} - 0.1\text{ V}$ ,	—	8	—	bits
Nonlinearity error	LE		$V_{SS} \geq 0.1\text{ V}$ , no load	-1.5	—	1.5	LSB
Differential linearity error	DLE		load	-1.0	—	1.0	LSB

**Nonlinearity error:** Deviation (error) in input/output curves with respect to an ideal straight line connecting output voltage at "00" and output voltage at "FF."

**Differential linearity error:** Deviation (error) in amplification with respect to theoretical increase in amplification per 1-bit increase in digital value.



Note: The value of  $V_{AOH}$  and  $V_{DD}$ , and the value of  $V_{AOL}$  and  $V_{SS}$  are not necessarily equivalent.

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## (3) Analog Block 2

( $V_{DD}$ ,  $V_{CC}$  = +2.7 V to 3.6 V ( $V_{CC} \geq V_{DD}$ ), GND,  $V_{SS}$  = 0 V,  $T_a$  = -20°C to +85°C)

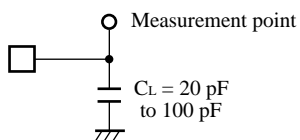
Parameter	Symbol	Pin	Condition	Value			Unit
				Min.	Typ.	Max.	
Output minimum voltage 1	$V_{AOL1}$	AO <sub>1</sub> to AO <sub>12</sub>	$V_{DD} = V_{CC} = 3.0$ V $V_{SS} = GND = 0.0$ V $I_{AL} = 0$ $\mu$ A Digital data = #00	$V_{SS}$	—	$V_{SS} + 0.1$	V
Output minimum voltage 2	$V_{AOL2}$		$V_{DD} = V_{CC} = 3.0$ V $V_{SS} = GND = 0.0$ V $I_{AL} = 500$ $\mu$ A Digital data = #00	$V_{SS} - 0.2$	$V_{SS}$	$V_{SS} + 0.2$	V
Output minimum voltage 3	$V_{AOL3}$		$V_{DD} = V_{CC} = 3.0$ V $V_{SS} = GND = 0.0$ V $I_{AH} = 500$ $\mu$ A Digital data = #00	$V_{SS}$	—	$V_{SS} + 0.2$	V
Output minimum voltage 4	$V_{AOL4}$		$V_{DD} = V_{CC} = 3.0$ V $V_{SS} = GND = 0.0$ V $I_{AL} = 0$ $\mu$ A Digital data = #00	$V_{SS} - 0.3$	$V_{SS}$	$V_{SS} + 0.3$	V
Output minimum voltage 5	$V_{AOL5}$		$V_{DD} = V_{CC} = 3.0$ V $V_{SS} = GND = 0.0$ V $I_{AH} = 1.0$ mA Digital data = #00	$V_{SS}$	—	$V_{SS} + 0.3$	V
Output maximum voltage 1	$V_{AOH1}$		$V_{DD} = V_{CC} = 3.0$ V $V_{SS} = GND = 0.0$ V $I_{AL} = 0$ $\mu$ A Digital data = #FF	$V_{DD} - 0.1$	—	$V_{DD}$	V
Output maximum voltage 2	$V_{AOH2}$		$V_{DD} = V_{CC} = 3.0$ V $V_{SS} = GND = 0.0$ V $I_{AL} = 500$ $\mu$ A Digital data = #FF	$V_{DD} - 0.2$	—	$V_{DD}$	V
Output maximum voltage 3	$V_{AOH3}$		$V_{DD} = V_{CC} = 3.0$ V $V_{SS} = GND = 0.0$ V $I_{AH} = 500$ $\mu$ A Digital data = #FF	$V_{DD} - 0.2$	$V_{DD}$	$V_{DD} + 0.2$	V
Output maximum voltage 4	$V_{AOH4}$		$V_{DD} = V_{CC} = 3.0$ V $V_{SS} = GND = 0.0$ V $I_{AL} = 1.0$ mA Digital data = #FF	$V_{DD} - 0.3$	—	$V_{DD}$	V
Output maximum voltage 5	$V_{AOH5}$		$V_{DD} = V_{CC} = 3.0$ V $V_{SS} = GND = 0.0$ V $I_{AH} = 1.0$ mA Digital data = #FF	$V_{DD} - 0.3$	$V_{DD}$	$V_{DD} + 0.3$	V

## 2. AC Characteristics

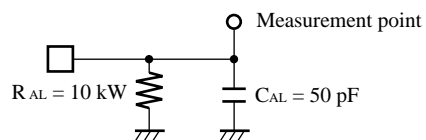
( $V_{DD}$ ,  $V_{CC} = +2.7\text{ V to }3.6\text{ V}$  ( $V_{CC} \geq V_{DD}$ ),  $GND$ ,  $V_{SS} = 0\text{ V}$ ,  $T_a = -20^\circ\text{C to }+85^\circ\text{C}$ )

Parameter	Symbol	Condition	Value		Unit
			Min.	Max.	
Clock L level pulse width	tCKL	—	200	—	ns
Clock H level pulse width	tCKH	—	200	—	ns
Clock rise time Clock fall time	tCr tCf	—	—	200	ns
Data setup time	tDCH	—	30	—	ns
Data hold time	tCHD	—	60	—	ns
Load setup time	tCHL	—	200	—	ns
Load hold time	tLDC	—	100	—	ns
Load H level pulse width	tLDH	—	100	—	ns
Data output delay time	tDO	See “• Load condition 1”	70	600	ns
D/A output settling time	tLDD	See “• Load condition 2”	—	300	$\mu\text{s}$

• Load condition 1

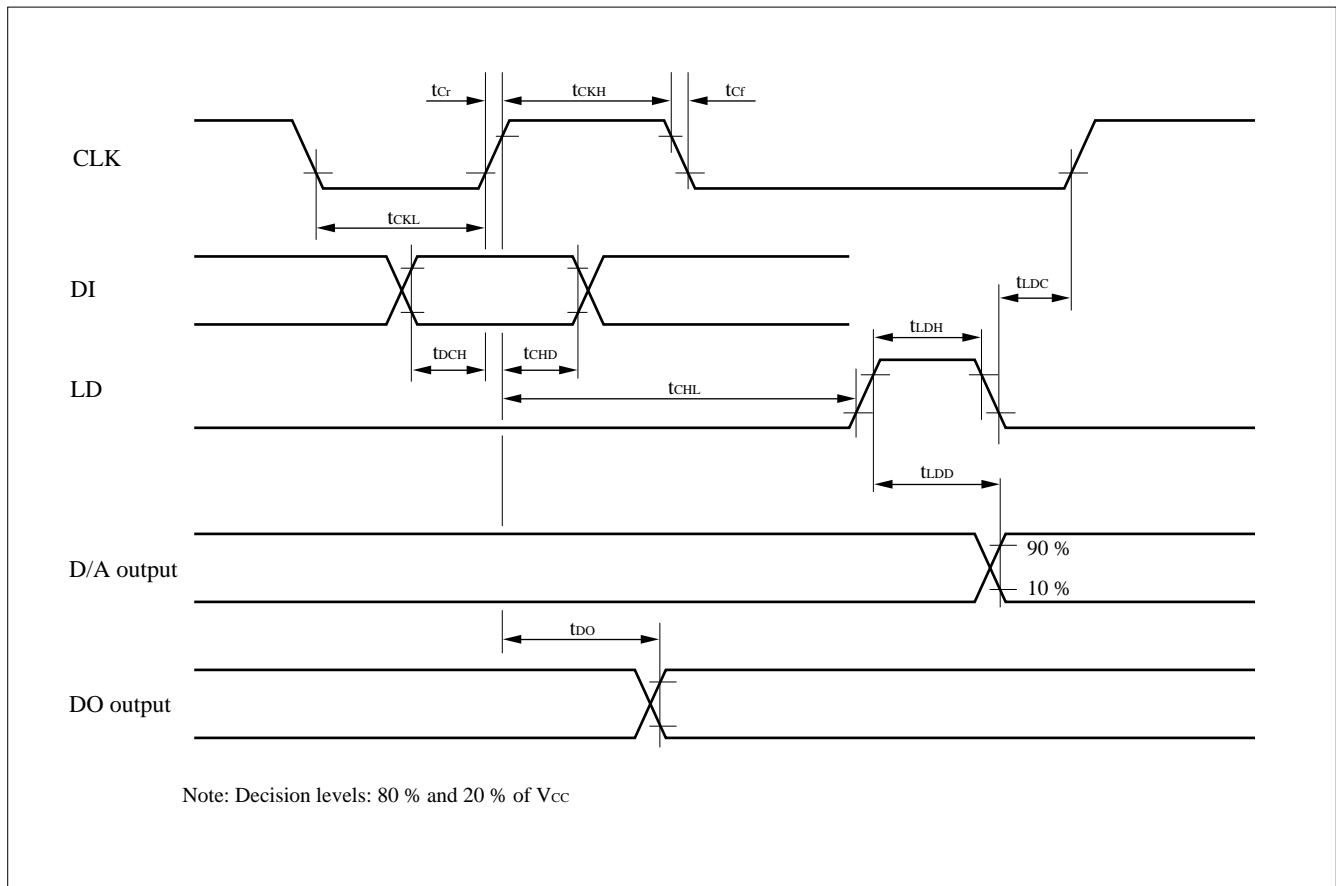


• Load condition 2

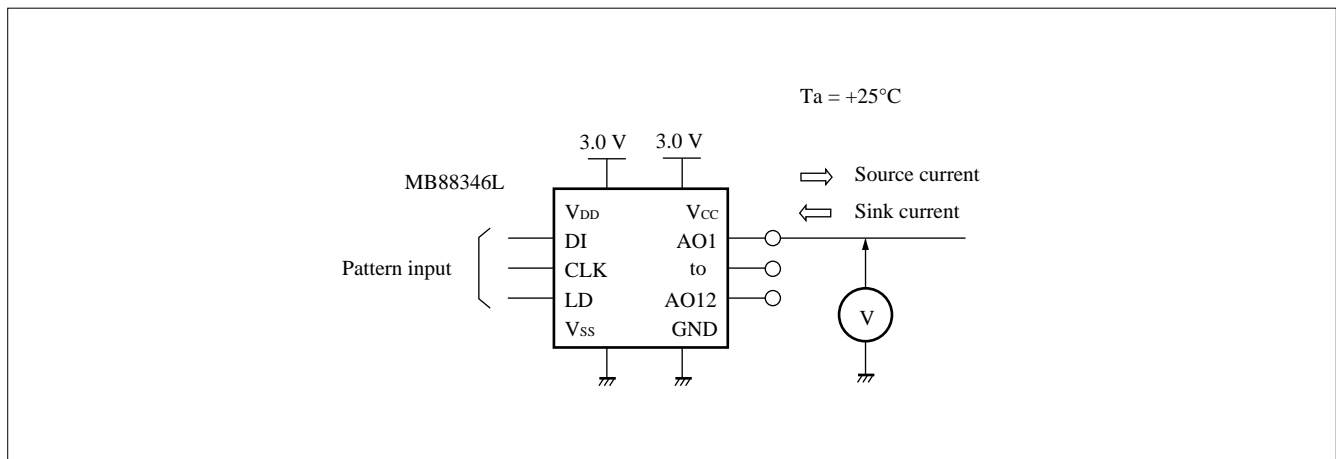


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## • Input/output timing

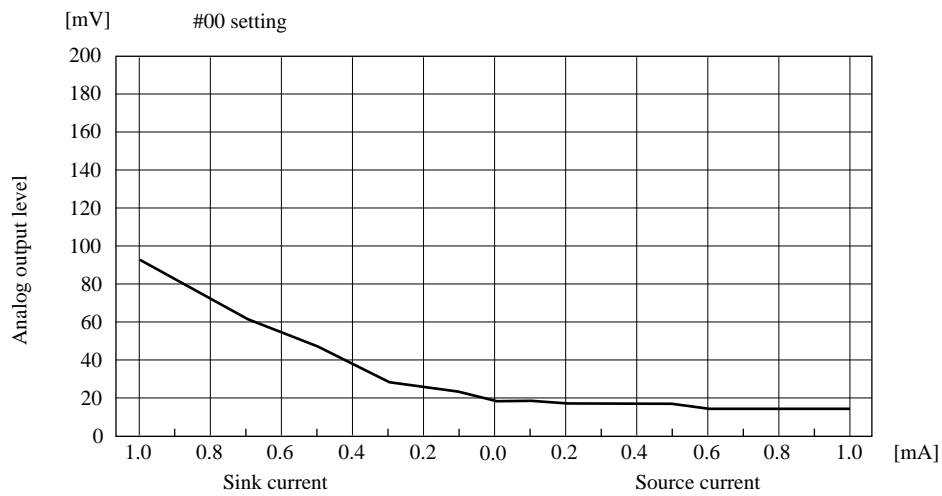
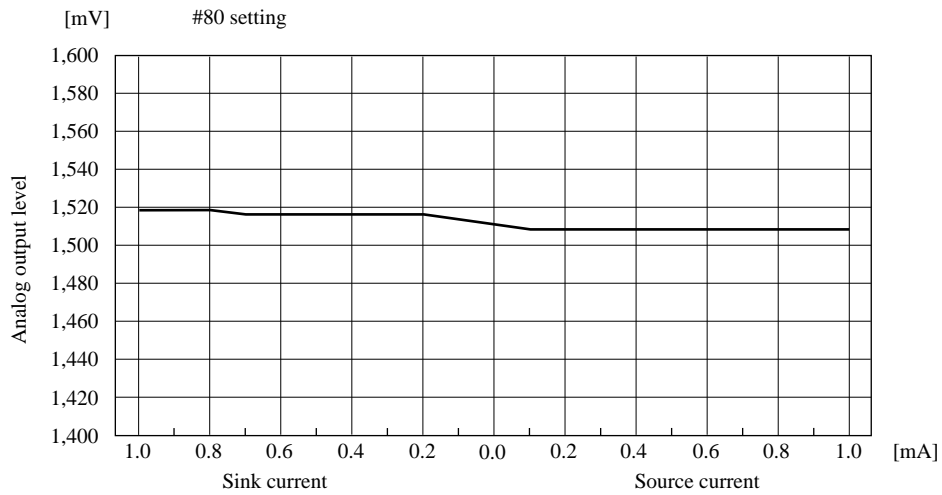
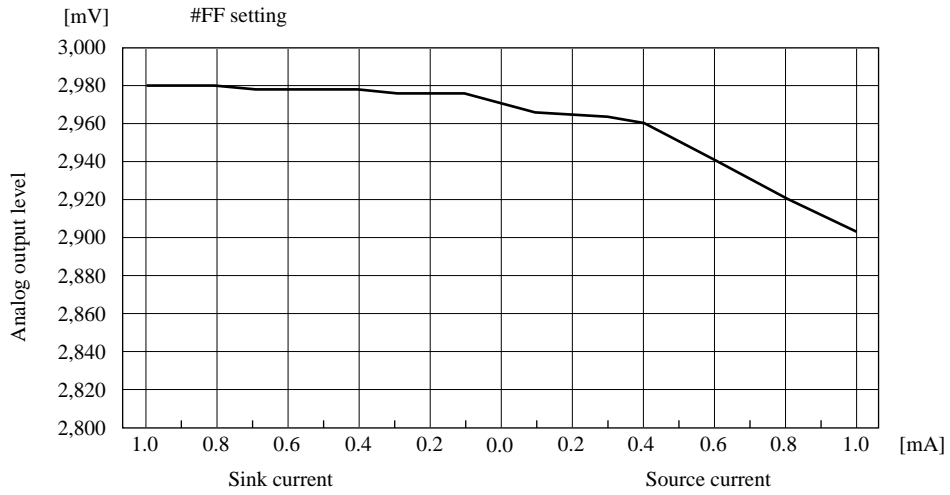


## ■ $V_{AO}$ vs. $I_{AO}$ CHARACTERISTICS: EXAMPLE



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# MB88346L

## ■ ORDERING INFORMATION

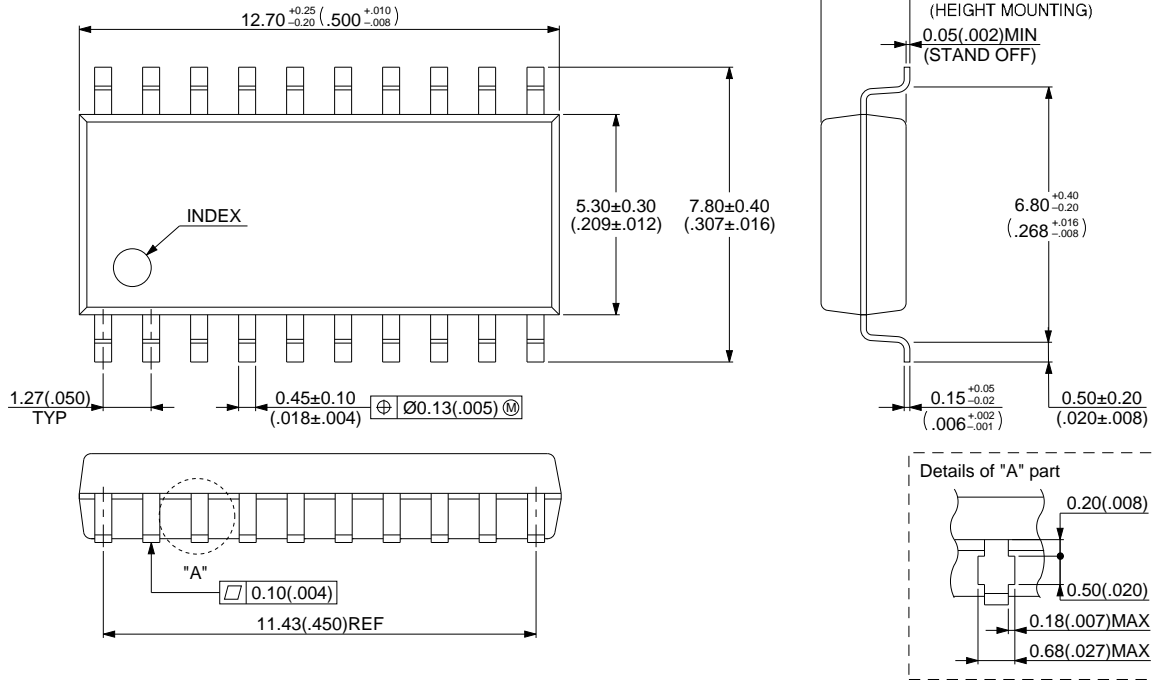
Part number	Package	Remarks
MB88346LP	20-pin Plastic DIP (DIP-20P-M02)	
MB88346LPF	20-pin Plastic SOP (FPT-20P-M01)	
MB88346LPFV	20-pin Plastic SSOP (FPT-20P-M03)	



# MB88346L

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## 20-pin Plastic SOP (FPT-20P-M01)



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Dimensions in mm (inches)

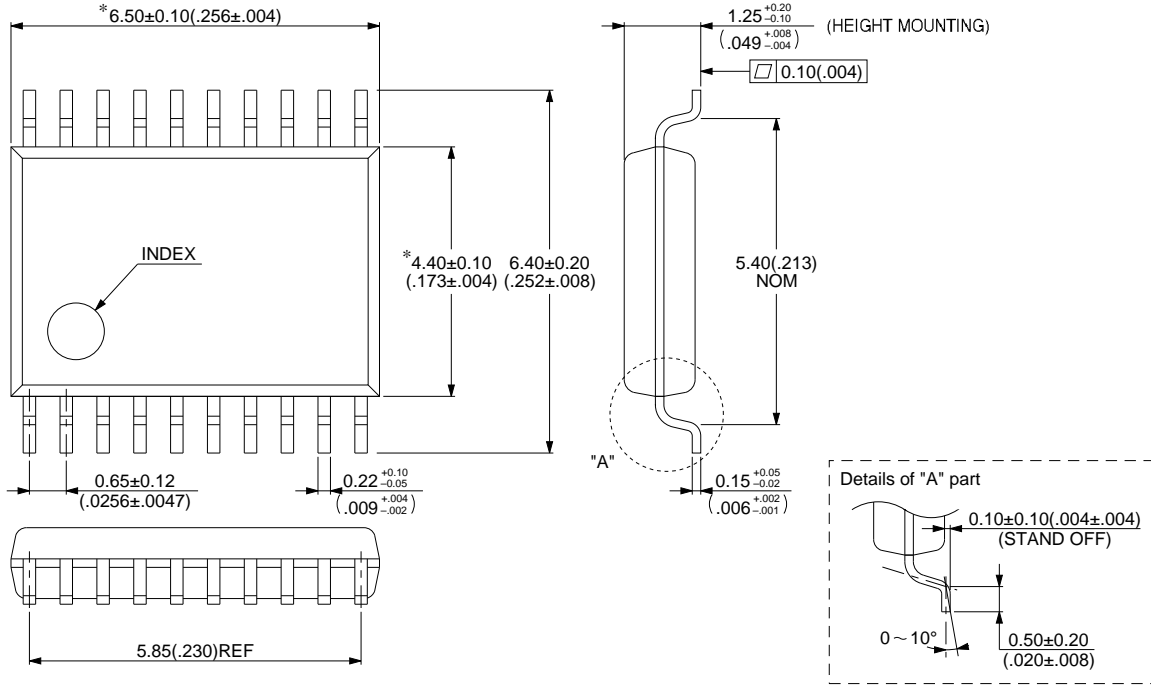
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## 20-pin Plastic SSOP (FPT-20P-M03)

\*:This dimension does not include resin protrusion.



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Dimensions in mm (inches)

# FUJITSU LIMITED

*For further information please contact:*

## **Japan**

FUJITSU LIMITED  
Corporate Global Business Support Division  
Electronic Devices  
KAWASAKI PLANT, 4-1-1, Kamikodanaka  
Nakahara-ku, Kawasaki-shi  
Kanagawa 211-88, Japan  
Tel: (044) 754-3763  
Fax: (044) 754-3329

## **North and South America**

FUJITSU MICROELECTRONICS, INC.  
Semiconductor Division  
3545 North First Street  
San Jose, CA 95134-1804, U.S.A.  
Tel: (408) 922-9000  
Fax: (408) 432-9044/9045

## **Europe**

FUJITSU MIKROELEKTRONIK GmbH  
Am Siebenstein 6-10  
63303 Dreieich-Buchsschlag  
Germany  
Tel: (06103) 690-0  
Fax: (06103) 690-122

## **Asia Pacific**

FUJITSU MICROELECTRONICS ASIA PTE. LIMITED  
#05-08, 151 Lorong Chuan  
New Tech Park  
Singapore 556741  
Tel: (65) 281-0770  
Fax: (65) 281-0220

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